

FEATURE

- ◆ -30V/-4.3A, $R_{DS(ON)}=44m\Omega$ (typ.)@ $V_{GS}=-10V$
- ◆ -30V/-3.5A, $R_{DS(ON)}=50m\Omega$ (typ.)@ $V_{GS}=-4.5V$
- ◆ -30V/-2.5A, $R_{DS(ON)}=65m\Omega$ (typ.)@ $V_{GS}=-2.5V$
- ◆ Super high design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and Maximum DC current capability
- ◆ Full RoHS compliance
- ◆ SOT23-3 package design

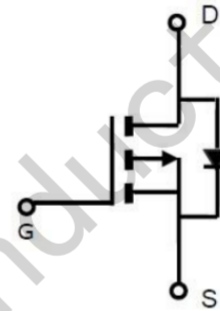
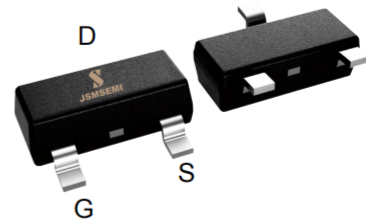
DESCRIPTION

The SI2319CDS-T1-GE3 is the P-Channel logic enhancement mode power field effect transistor is produced using high cell density advanced trench technology..

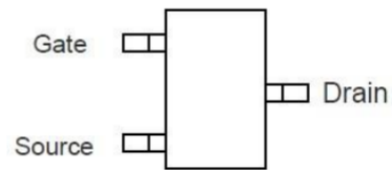
This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, and low in-line power loss are needed in a very small outline surface mount package.

APPLICATIONS

- ◆ Power Management
- ◆ Portable Equipment
- ◆ DC/DC Converter
- ◆ Load Switch
- ◆ DSC
- ◆ LCD Display inverter



P-Channel



TOP VIEW
SOT-23

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless otherwise noted)

Symbol	Parameter		Typical	Unit
V_{DSS}	Drain-Source Voltage		-30	V
V_{GSS}	Gate-Source Voltage		± 12	V
I_D	Continuous Drain Current ($T_C=25^\circ\text{C}$)	$V_{GS}=-10V$	-4.3	A
	Continuous Drain Current ($T_J=70^\circ\text{C}$)		-4.0	
I_{DM}	Pulsed Drain Current		-20	A
I_S	Continuous Source Current (Diode Conduction)		-1.5	A
P_D	Power Dissipation	$T_A=25^\circ\text{C}$	1.5	W
		$T_A=70^\circ\text{C}$	0.9	
T_J	Operation Junction Temperature		150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range		-55~+150	$^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient		120	$^\circ\text{C/W}$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress rating only and functional device operation is not implied

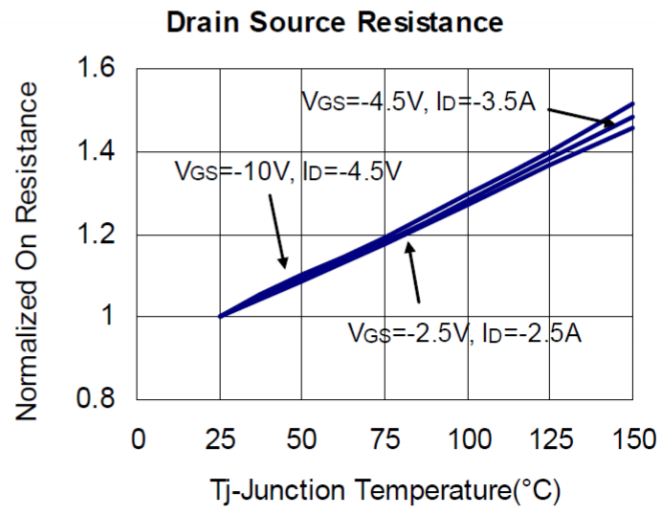
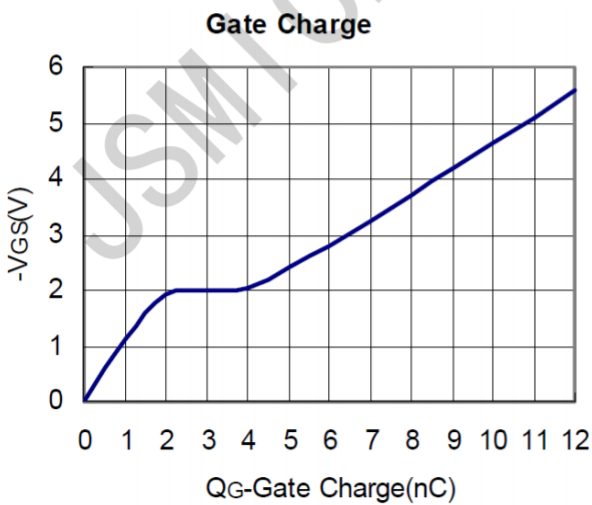
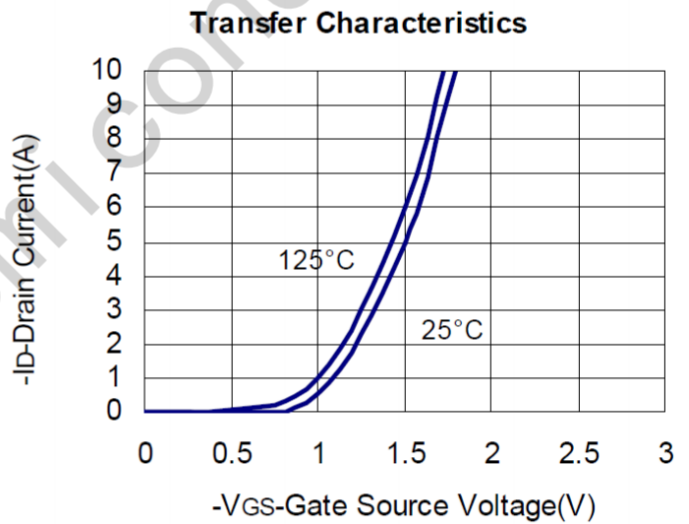
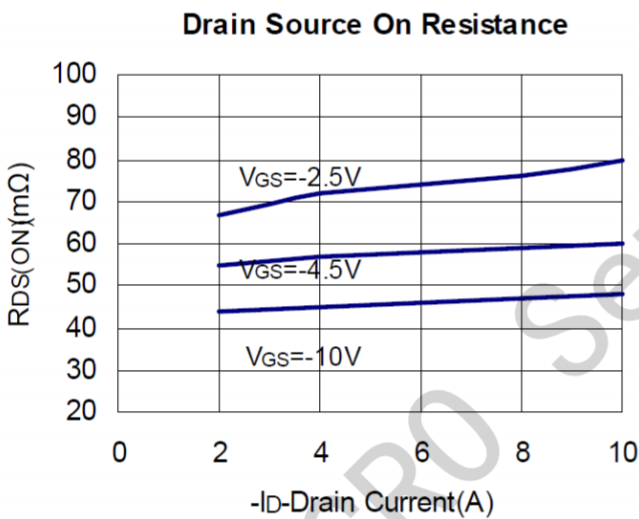
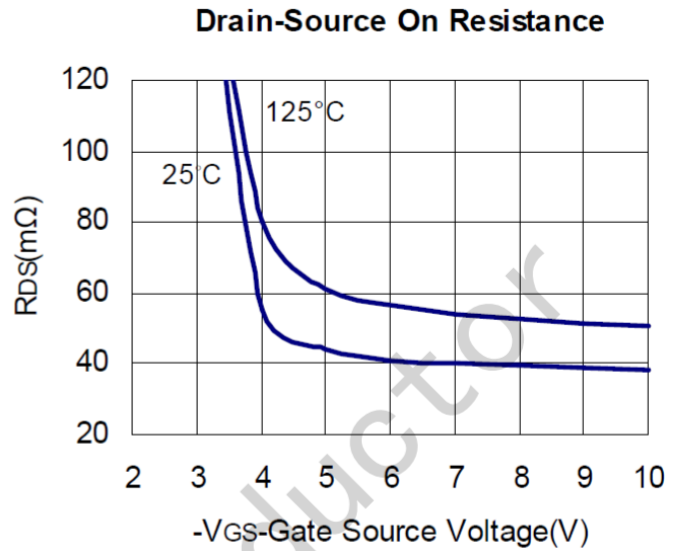
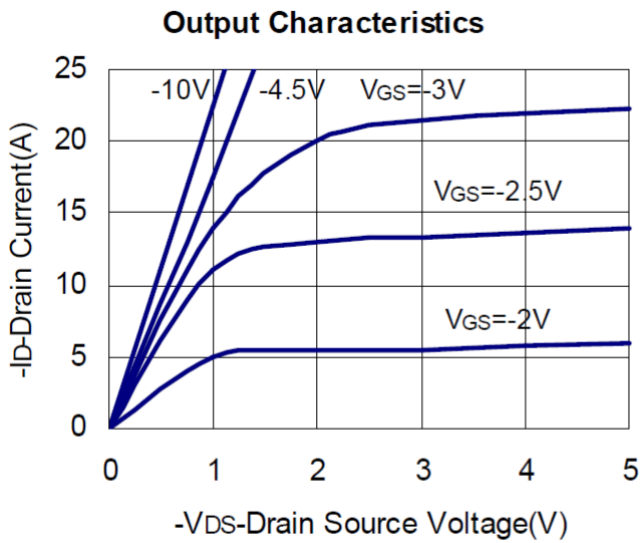
ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$ Unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Parameters						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-30			V
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.6		-1.2	V
I_{GSS}	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 12V$			± 100	nA
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-24V, V_{GS}=0$			-1	uA
		$V_{DS}=-24V, V_{GS}=0$ $T_J=55^\circ\text{C}$			-5	
$R_{DS(on)}$	Drain-Source On-Resistance	$V_{GS}=-10V, I_D=-4.3A$		44	52	mΩ
		$V_{GS}=-4.5V, I_D=-3.5A$		50	58	
		$V_{GS}=-2.5V, I_D=-2.5A$		65	78	
Source-Drain Diode						
V_{SD}	Diode Forward Voltage	$I_S=-1.0A, V_{GS}=0V$		-0.7	-1.0	V
Dynamic Parameters						
Q_g	Total Gate Charge	$V_{DS}=-20V$ $V_{GS}=-4.5V$ $I_D=-4.0A$		6.2		nC
Q_{gs}	Gate-Source Charge			2.8		
Q_{gd}	Gate-Drain Charge			3.0		
C_{iss}	Input Capacitance	$V_{DS}=-12V$ $V_{GS}=0V$ $f=1\text{MHz}$		672		pF
C_{oss}	Output Capacitance			280		
C_{rss}	Reverse Transfer Capacitance			102		
$T_{d(on)}$	Turn-On Time	$V_{DS}=-12V$ $I_D=-4A$		9		nS
T_r				15		
$T_{d(off)}$	Turn-Off Time	$V_{GEN}=-10V$ $R_G=3.3\Omega$		23		
T_f				21		

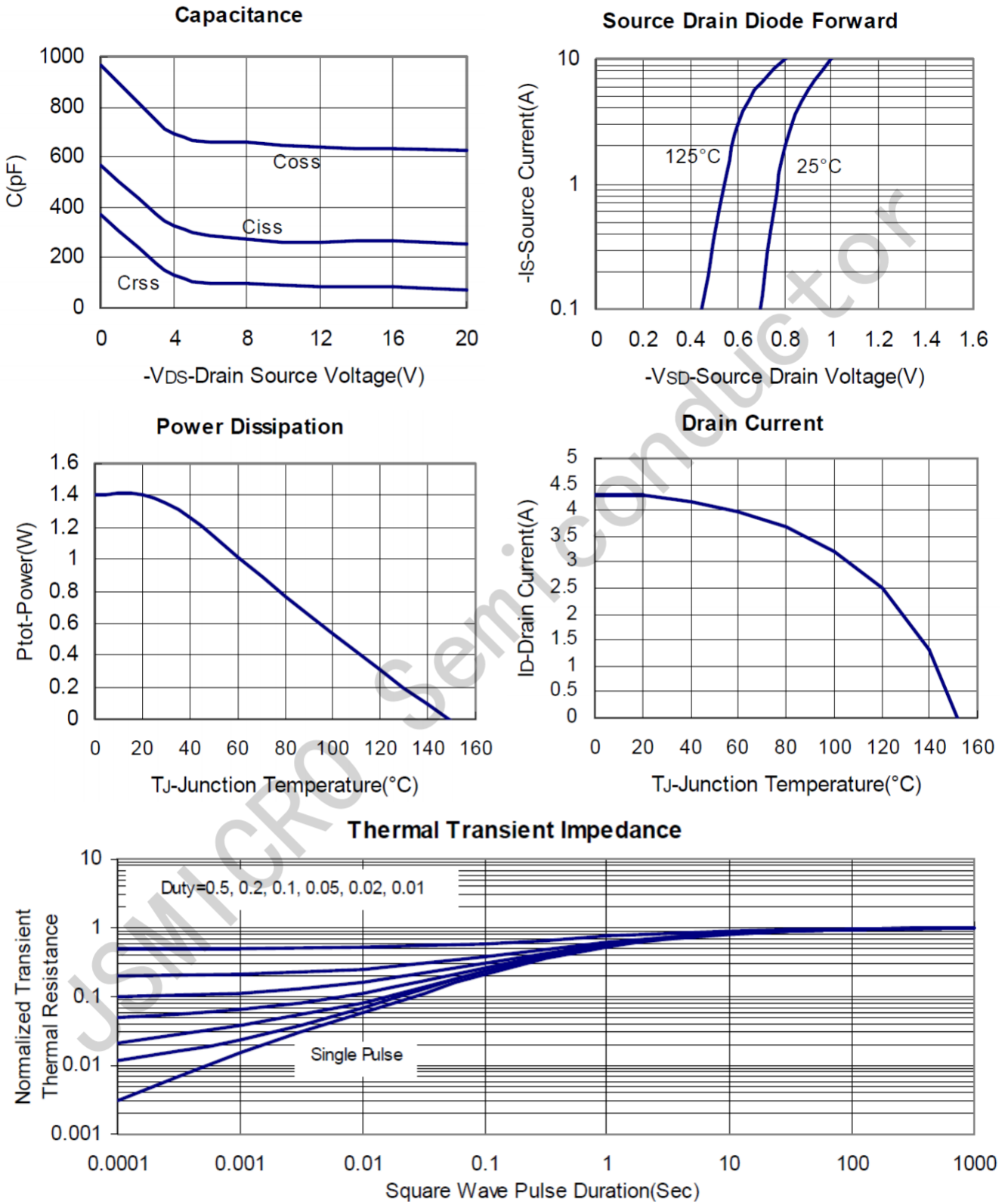
Note: 1. Pulse test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$

2. Static parameters are based on package level with recommended wire bonding

■ **TYPICAL CHARACTERISTICS** (25 °C Unless Note)

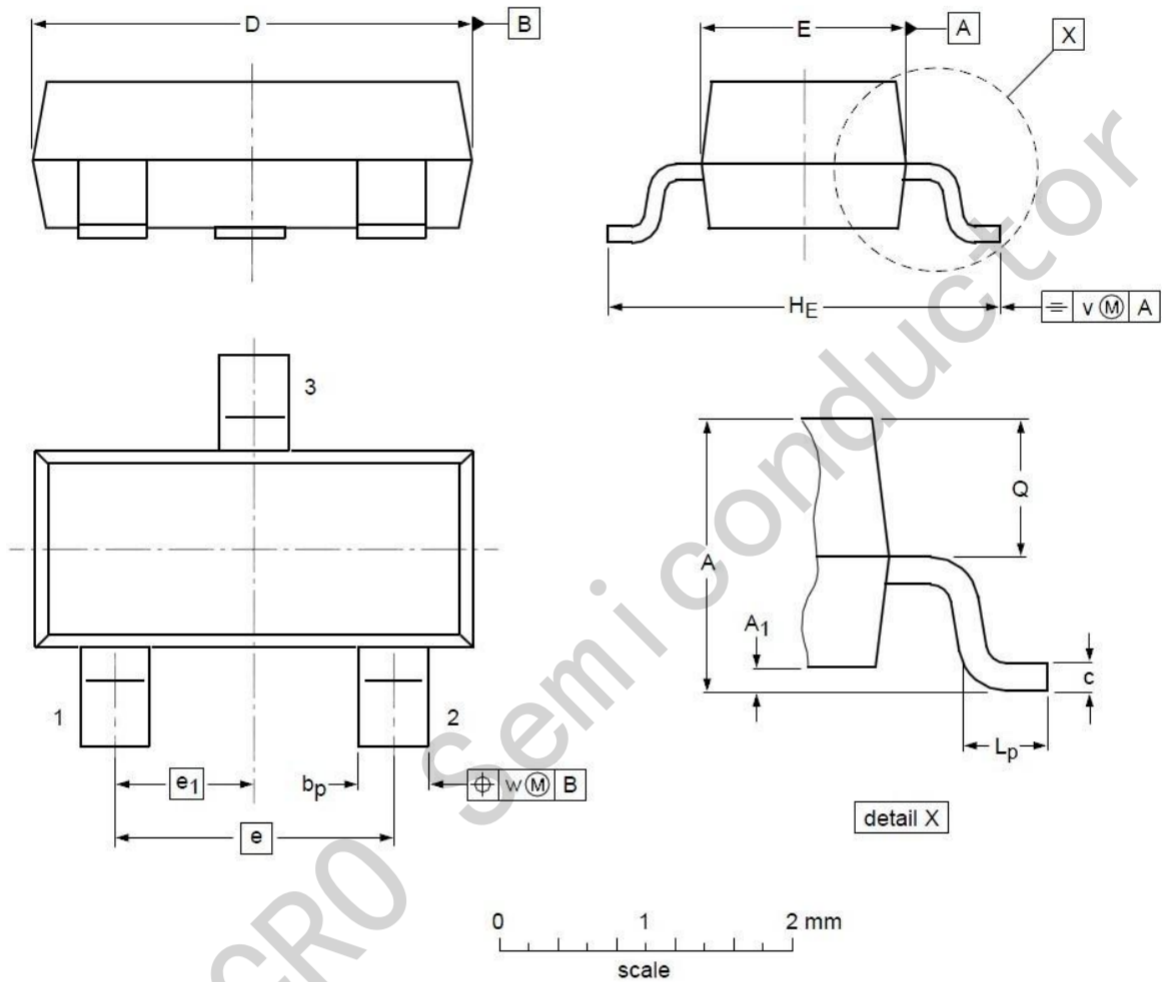


■ **TYPICAL CHARACTERISTICS** (continuous)



Package Information

SOT-23-3



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.01	1.15	A ₁	0.01	0.05	0.10
b _p	0.30	0.42	0.50	c	0.08	0.13	0.15
D	2.80	2.92	3.00	E	1.20	1.33	1.40
e	--	1.90	--	e ₁	--	0.95	--
H _E	2.25	2.40	2.55	L _p	0.30	0.42	0.50
Q	0.45	0.49	0.55	v	--	0.20	--
w	--	0.10	--				

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